# 1.5mm-travel horizontal type with external type knob

1.5mm-travel, with External Knob Type



# ■ Typical Specifications

Ite	ms	Specifications		
Rating (max.)/(mi	n.) (Resistive load)	1mA 5V DC/50μA 3V DC		
Contact resistand (Initial performand		$100$ m $\Omega$ max./ $200$ m $\Omega$ max.		
Operating force		2-position	3-position	
Operating force		2.5±1.5N	a, c → b 2±1.5N b → a, c 2.5±1.5N	
Operating life	Without load	10,000 cycles		
Operating life	With load	10,000 cycles (1mA 5V DC)		

# Product Line

Travel Actuator Actuator	Poloc	Pocitions	Mounting Cha	Changeover c	Soldering	Minimum order unit (pcs.)		Product No.	Drawing
(mm)	direction	length (mm) Poles Positions   Mounting method   Changeover   Soldering		Japan	Export	Floudet No.	No.		
1.5 Horizontal 3.2	30	30 0	2 Press-in	Non shorting	Manual, Dip	1600	1,600 8,000	SSAC120100	1
		3	F1655-III	Not specified		1,000		SSAC120200	2

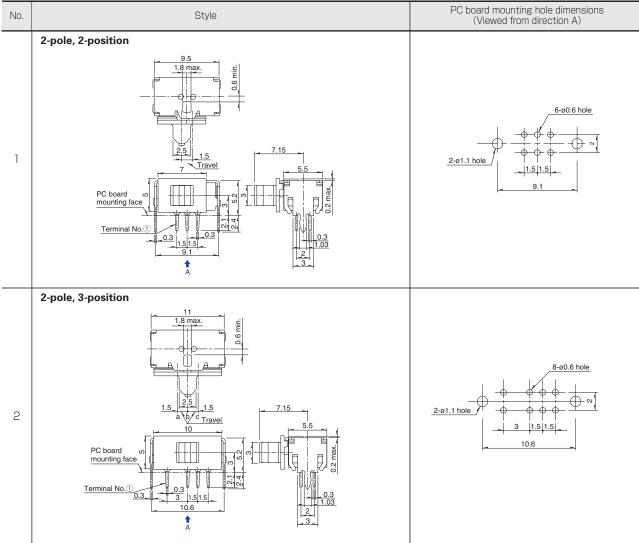
# Packing Specifications

### Bulk

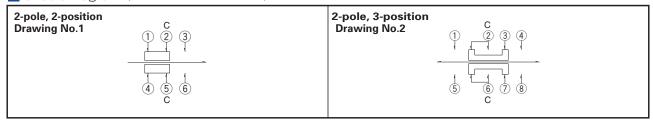
Number of pa	Export package measurements	
1 case /Japan	1 case /export packing	(mm)
1,600	8,000	400×270×290

Unit:mm

Dimensions



# Circuit Diagram (Viewed from Direction A)



Series		SSSS2%	SSSS9	SSAC	SSSF	SSSU		
Photo								
Actuator direction		Horizontal	•	•	•	•	•	
		Vertical	•	•	_	•	•	
		1-2	•	•	_	•	•	
		1-3	•	•	_	•	•	
		1-4	•	_	_	_	_	
Poles-pos	itions	2-2	•	•	•	•	•	
		2-3	•	•	•	•	•	
		2-4	•	_	_	_	_	
		4-2	_	_	_	•	•	
Т	ravel (mm	)	2	2	1.5	2	3	
Operating	temperat	ure range	-40℃ t	:o +85℃	-10°C to +60°C	-40℃ t	o +85℃	
Aut	Automotive use		_	_	_	_	_	
	Life cycle		*3	*3	<b>★</b> 3	<b>*</b> 3	*3	
Ra (Re	ating (max esistive loa	i.) ad)	0.3A 6V DC	0.1A 12V DC	1mA 5V DC	mA 5V DC 0.1A 30V DC		
	ating (min esistive loa		50μA 3V DC	1mA 5V DC	50μA 3V DC	10μΑ	IV DC	
D 137	Operating life without load		10,000 cycles 100mΩ max.*	10,000 cycles 60mΩ max.	10,000 cycles 45		s 45mΩ max.	
Durability	Operating life with load Load: as rating		10,000 cycles 130mΩ max.%	10,000 cycles 80mΩ max.	200mΩ max. 10,000 cycles 65m:		s 65mΩ max.	
		contact stance	70mΩ max.	30mΩ max.	100mΩ max.	25mΩ max.		
Electrical performance	Insulation	n resistance	100MΩ min. 500V DC		100MΩ min. 100V DC	100MΩ min. 500V DC		
	Volta	ge proof	500V AC for 1minute		100V AC for 1minute	500V AC for 1minute		
	Termina	al strength	3N for	lminute	5N for 1minute			
Mechanical performance	Actuator	Operating direction	20N	30N	- 5N		0011	
	strength	Pulling direction	10	DN	NIC	30N		
	Cold		-20℃ 500h	-40℃ 500h	-20°C 96h -40°C 500h		500h	
Environmental performance	Dry heat		85°C	500h	85℃ 96h	85°C	500h	
	Damp heat		60°C, 90 to 9	95%RH 500h	40°C, 90 to 95%RH 96h	60°C, 90 to 9	5%RH 500h	
	Page		92	97	103	105	109	

#### Notes

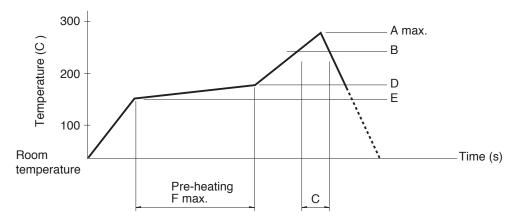
- 1. \* Operating life for SSSS213202 is 100 cycles.
- 2. Indicates applicability to all products in the series.

# Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple  $\phi$  0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.

Slide Switches Soldering Conditions

3. Temperature profile



Series (Reflow type)		A (℃) 3s max.	B (℃)	C (s)	D (°C)	E (℃)	F(s)	
Vertical		1-pole, 3-position						
SSSS2	SSSS2 Horizontal	1-pole, 2-position 1-pole, 3-position 2-pole, 3-position	260	230	40	180	150	120
Vert	Vertical	1-pole, 2-position	250					
SSSS7		250						
SSAH, S	SSAH, SSAG, SSAJ, SSAL, SSSS8		260					

# Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

### ■ Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SSSF, SSSU	350±10℃	3+1/0s	
SSSS2	350±10℃	4s max.	
SSSS9	350±10℃	3s max.	
SSAH, SSAG, SSAJ, SSAL	350±5℃	3s max.	
SSSS8	330±5℃	3s max.	
SSSS7	320±5℃	3s max.	
SSAC	300±10℃	2s max.	

# Reference for Dip Soldering (For PC board terminal types)

Series	Ite	ms	Dip soldering		
Octios .	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSSS2	100°C max.	60s max.	260±5℃	3±1s	
SSSS9	120°C max.	60s max.	260±5℃	5+0/-1s (2 times)	
SSSF, SSSU	100°C max.	60s max.	260±5℃	10±1s/5±1s	
SSAC	100°C max.	60s max.	260±5℃	5±1s	



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ALPS:

SSAC120100 SSAC120200